

FAILURE of Nd:YVO₄ AMPLIFIER CRYSTALS

Jon Salem NASA GRC Cleveland, Ohio



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Ceramics are used in Many NASA Applications

- Solar concentrators
- Specialty windows
- Lenses
- Spectrometer components
- Low expansion mounting plates ---
- Laser amplifiers









ICESat-2

Ice, Cloud, and Land Elevation Satellite



- The four ICESat-2 science objectives are
 - Measure melting of ice sheets and sea level rise
 - Measure changes in the mass of ice sheets and glaciers
 - Estimate and study sea ice thickness
 - Measure the height of vegetation in forests worldwide





ICESat-2

Ice, Cloud, and Land Elevation Satellite



- ICESat-2 carries a single instrument the Advanced Topographic Laser Altimeter System (ATLAS):
 - ATLAS measures the travel times of lasers pulses to calculate the distance between the spacecraft and Earth's surface.



ATLAS Instrument





4



Within the System are Nd:YVO₄ Crystals

- The YVO₄ single crystals are laser "slabs"
- Elastic modulus = 220 GPa <a> axis
- Fracture toughness = 0.48 MPa \sqrt{m}
- Fracture strength = 46 MPa (~7 ksi)
- Slow crack growth n = 17









> Very brittle!!



Surfaces of the Crystals

• Diamond ground, with surfaces that tend to be damaged (chips, scratches, etc.):









One would expect surface failure.



Failure of the Crystals

• Indeed, strength test specimens fail from surface flaws:







Failed Crystals in Hardware

- Four failures are of particular interest:
 - Two that failed unexpectedly in flight hardware; these brought me into the project.
 - Two failed during bench testing while attempting to understand the prior failures; these created confusion about the nature of failure. These exhibited interesting patterns.





First Pump-to-Failure Amplifier Crystal - Failed During Bench Testing -

- During routine bench testing of a laser amplifier slab, the control loop was lost and the crystal over-pumped until fracture occurred.
- Disassembly revealed a fracture near one end, with the location of fracture thought to be near the center.







Over-pumped Crystal:



- Pronounced swirl at a central "node:"
- Failure located on the {a} crystal plane without macroscopic rotation from the {a} plane.
- Some felt that failure occurred from the center "node".....

Fractured at 2.6 mm





Stress State at High Power

• X-axis, <a>, principal stresses:



- Center compression with edge tension, where the worst flaws are often located.
- Compressive strength is >> tensile strength.



Location of Speculated Origin

• Speculated origin is on the border of compression and tension, with low tensile stresses (~5 MPa):



• Could the origin be elsewhere? The surface?



Other Fracture Features

 Let's consider surfaces where stresses and damage are high:



• At the surface a star-like feature is apparent – single crystal mirror?



Surface Damage and Classic Mirror



 But why the coalescence of river marks to a central region of initial compression??



River Marks Follow Tensile Stress Pattern...

- As the crack grows, it spirals, avoiding the center compression, changing the center to tension until the cracks paths converge (?).
- The crack remains on the cleavage plane rather than tracking along the beam long axis:





• No mirror or hackle markings on one side of the origin!!??.....



"All Roads Lead to Rome" (or away!)

- Origin appears to be the corner of a small, semi-circular surface crack.
- Growing crack wraps around one side of the step.....Unusual



• "Rome" is the interface between tension and compression where the crack front stalls? But that hackle......



Why No Hackle on one Side of the Origin?

• By side lighting, we see that the slab was cracked, likely prior to the fracture:



Crack wrapped around the prior, longitudinal crack plane like a screw, creating the cleavage step and "node."



X and Y Direction Stresses are Similar:



- Grinding is usually in the x-direction, and the stresses are similar on both the x- and y-directions, so longitudinal cracking is likely.
- Longitudinal crack was in tension, creating a stress concentration and drawing in the propagating crack.....creating the "node."





Estimated Stress (Fractographic and FEA)



• High stresses are estimated, implying that the stresses were higher due to the prior longitudinal crack or that the pump level, which was unknown, was very large.



Second Pump-to-Failure Amplifier Crystal - Failed During Bench Testing -

- Controlled bench test of a laser amplifier slab (single crystal) to induce crystal failure via over-pumping.
- Disassembly revealed a fracture near one end, with the location of fracture thought to be near the center.







Slab: Pump-to-Failure Fracture

• The "Node" is more centrally located (compression) and no cleavage step or prior longitudinal crack is apparent:



- Crack wrapped around central compression region and stalled.
- Stress state changed and fracture continued by failing central ligament as regions of compression became tension, creating the node.



Amplifier Assembly Overview



- The Nd:YVO₄ crystals are clamped between two gold plated heat spreaders with an indium foil thermal interface material.
- The indium foil thickness was custom selected to achieve uniform and simultaneous contact between all five planar surfaces.
- Four bolts are used to attach the clamp to the mount securing the crystal.



First Flight Amplifier Fracture

- The crystal fractured about 10 mm inboard of the input face and originated in the middle of the cfacet.
- There were no obvious surface defects or corresponding mount defects at the fracture origin.
- Applied stresses were low.
- Implies that the crystal was under higher mechanical loads (pressure).
- But why?

Courtesy Fibertek Inc.







Time Dependent Crystal Loading

Mount / Clamp Interface



- Fractography indicated that gold and indium were forming gold-indide (AuIn₂) over time.
- The resulting AuIn₂ material is stiffer, harder and more brittle than indium; and more significantly, occupies 15% more volume.
- Intermetallic and indium are incompressible. The additional volume is displaced, resulting in higher preloads on the crystal, and eventual fracture.
- ➢ Failure was not due to overpumping...



Redesign Philosophy

- Failure resulted from several sources:
 - Au-In reactions (worst element)
 - poor crystal finishing and handling
 - low toughness and slow crack growth
- Re-design & qualification was needed:
 - Lowered the stresses
 - Quantified the transient reliability:
 - Weakest Link Behavior:
 - Structure is analogous to a chain with many links of differing strength
 - Catastrophic failure occurs when the weakest link is broken
 - A longer chain is weaker







Conclusions

- For the first slab, cracking started from an {a}-plane semi-elliptical crack located on one side of a prior, longitudinal {a}-plane crack.
- The crack wrapped around the prior, {a}-plane crack by following high tension regions near the surface, creating a large cleavage step.
- As the crack spiraled around and inward, compression regions diminished until central tension occurred via stress redistribution. Stopped spiraling inward at the prior crack tip.
- The prior crack acted as a concentrator, attracting moving crack.
- For the second slab, cracking started from the surface.
- The crack wrapped around both sides of the central compression region and move inward as stress redistribution occurred, forming the central "node."
- Nodal formation is the result of a growing crack being attracted to a point: reaming central ligament of a crack tip.
- Two flight hardware fractures were from the surface and driven predominantly by chemical reactions.....



Conclusions

• The node formation and resulting pattern leads to a new fractography term:

Hackle Node - the coalescence of hackle lines (river marks) to a point of prior compression. The feature is produced as a thermally generated, centrally located compressive region transforms to tension thereby drawing crack propagation to a point.



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- a. Fibertek, Inc., 13605 Dulles Technology Drive, Herndon, VA 20171
- b. NASA Goddard Space Flight Center, Greenbelt, MD 20771;
- c. NASA Glenn Research Center, Cleveland, OH 44135



ICESat-2 Integration After Redesign





- ICESat-2 was integrated at the Orbital/ATK facility in AZ.
- EMI testing completed in April, 2018.
- Transported to Vandenberg AFB in May for integration onto the rocket.
 - The system was powered on for the last time on Earth in mid-June 2018!





ICEsat-2 Launched from Delta II Pad SLC 2W Vandenberg AFB – California 9-15-2018

